

#### Weidmüller Interface GmbH & Co. KG Klingenbergstraße 26

D-32758 Detmold Germany

www.weidmueller.com

#### **Product image**





Similar to illustration

#### High-temperature-resistant male header

- Finger-safe
- Can be plugged into female plug B2CF 3.50 PUSH IN
- Plug-in direction is perpendicular or parallel to the circuit board (180° / 90°)
- Housing variants: closed (G) and with solder flange (LF)
- Packed either in a box (BX) or on anti-static tapeon-reel (RL)
- Suitable for reflow and wave soldering applications
- Pin length of either 1.5 mm or 3.2 mm

#### **General ordering data**

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, Number of poles: 20, 90°, Solder pin length (I): 3.2 mm, tinned, black, Tape
Order No.	<u>1359550000</u>
Туре	S2C-SMT 3.50/20/90G 3.2SN BK RL
GTIN (EAN)	4050118162820
Qty.	235 pc(s).
Product data	IEC: 200 V / 13.4 A
	UL: 150 V / 10 A
Packaging	Таре

Creation date March 23, 2021 6:42:58 PM CET



#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Technical data**

Depth	14.2 mm	Depth (inches)	0.559 inch
Height	14 mm	Height (inches)	0.551 inch
Height of lowest version	10.8 mm	Net weight	5.576 g
Width	36.4 mm	Width (inches)	1.433 inch

#### **System specifications**

Product family	<b>OMNIMATE</b> Signal - series	Type of connection	
	B2C/S2C 3.50 - 2-row		Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	90°
Number of poles	20	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin dimensions	d = 1.0 mm, Octagonal
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (	0)+ 0,1 mm
Outside diameter of solder pad	2.1 mm	Template aperture diameter	1.9 mm
L1 in mm	31.5 mm	L1 in inches	1.24 inch
Number of rows	1	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	touch-safe on connector face, safe to back of hand above the printed circuit	Touch-safe protection acc. to DIN VDE 0470	
	board		IP 20
Can be coded	Yes	Plugging force/pole, max.	3.5 N
Pulling force/pole, max.	2.5 N		

#### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface		Layer structure of solder connection	13 µm Ni / 25 µm Sn
	tinned		matt
Layer structure of plug contact	25 µm Sn / 13 µm Ni	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-40 °C
Temperature range, installation, max.	120 °C		

#### Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	13.4 A
	120 00004-1, 120 01304		13:4 A
Rated current, min. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	12 A	pollution degree II/2	200 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	160 V	pollution degree III/3	80 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	2.5 kV	class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage		Short-time withstand current resistance	
class/ contamination degree III/3	2.5 kV		3 x 1s with 80 A



#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Technical data**

Rated	data	acc.	to	CSA
-------	------	------	----	-----

Institute (CSA)	<b>(1</b> )	Certificate No. (CSA)	
			200039-1121690
Rated voltage (Use group B / CSA)	150 V	Rated voltage (Use group C / CSA)	50 V
Rated voltage (Use group D / CSA)	150 V	Rated current (Use group B / CSA)	9.5 A
Rated current (Use group C / CSA)	9.5 A	Rated current (Use group D / CSA)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Rated data acc. to UL 1059			
Institute (cURus)		Certificate No. (cURus)	
			E60693
Rated voltage (Use group B / UL 1059)	150 V	Rated voltage (Use group C / UL 1059)	50 V
Rated current (Use group B / UL 1059)	10 A	Rated current (Use group C / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
Packaging	Таре	VPE length	0.33 m
/PE width	0.33 m	VPE height	0.06 m
Tape depth (T2)	15.1 mm	Tape width (W)	56 mm
Tape pocket depth (KO)	14.6 mm	Tape pocket height (A0)	14.5 mm
Tape pocket width (B0)	43.6 mm	Tape pocket separation (P1)	20 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	26.2 mm
Tape reel diameter Ø (A)	330 mm	Surface resistance	$Rs = 10^9 - 10^{12} \Omega$

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

**Technical data** 

### S2C-SMT 3.50/20/90G 3.2SN BK RL



#### Weidmüller Interface GmbH & Co. KG Klingenbergstraße 26

D-32758 Detmold Germany

www.weidmueller.com

Important note	
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Gold-plated contact surfaces on request
	Rated current related to rated cross-section & min. No. of poles.
	Spacing between rows: see hole layout
	• P on drawing = pitch
	<ul> <li>Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li> </ul>
	• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months
Approvals	
Approvals	
ROHS	Conform
UL File Number Search	E60693
Downloads	
Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	<u>STEP</u>

# Drawings

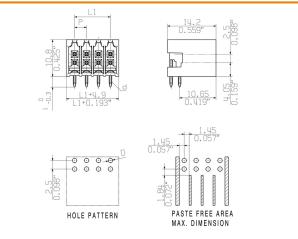


#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

#### **Dimensional drawing**



#### **Product benefits**



Optimised for the SMT process Safe board-to-board connection

# Drawings

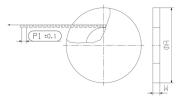
Weidmüller 🔀

#### Weidmüller Interface GmbH & Co. KG Klingenbergstraße 26

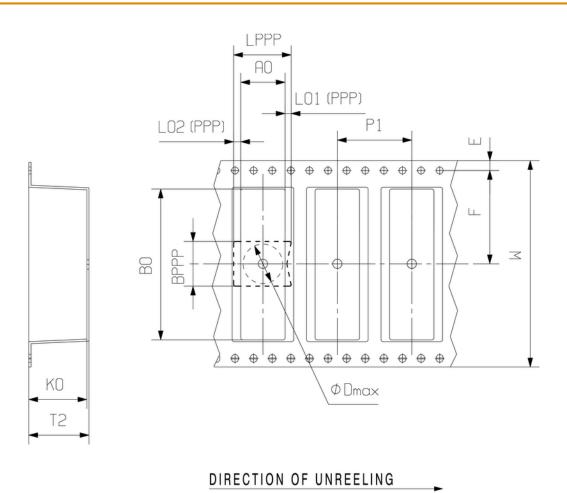
D-32758 Detmold Germany

www.weidmueller.com

#### Dimensional drawing



#### **Dimensional drawing**



#### Creation date March 23, 2021 6:42:58 PM CET

# Wave Solder Profile

#### **Recommended wave solderding profiles**

# Weidmüller 🟵

#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com



**Double Wave:** 

Single Wave:



#### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

# **Reflow Solder Profile**

### **Recommended reflow soldering profile**



#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com



Time [sec]

#### **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.